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(12) **United States Design Patent**  
**Suzuki**

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(54) **HEADPHONES**

(71) Applicant: **Onkyo Corporation**, Osaka (JP)

(72) Inventor: **Tomohisa Suzuki**, Tottori (JP)

(73) Assignee: **Onkyo Corporation**, Osaka (JP)

(\*\*) Term: **15 Years**

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(51) **LOC (11) Cl.** ..... **14-01**

(52) **U.S. Cl.**  
USPC ..... **D14/205**

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379/430, 431; 381/380, 381, 374;  
455/90.3, 575.1, 569.1; D29/112; 2/209  
CPC .... H04R 1/1066; H04R 1/1016; H04R 5/033;  
H04R 5/0335; H04R 25/00; H04R 25/02;  
H04R 1/10; H04R 1/105; H04R 1/1058  
See application file for complete search history.

(56) **References Cited**

**U.S. PATENT DOCUMENTS**

2,149,341	A *	3/1939	Harrison	.....	H04R 1/1066 248/274.1
2,924,290	A *	2/1960	Zuerker	.....	H04R 7/12 181/165
3,408,658	A *	11/1968	Beguin	.....	A61F 11/14 128/866
4,511,768	A *	4/1985	Patel	.....	H04R 1/222 181/144
D302,429	S *	7/1989	Leer	.....	D14/137
5,384,857	A *	1/1995	Nordin	.....	A61F 11/14 381/374
5,406,037	A *	4/1995	Nageno	.....	H04R 5/0335 181/129
6,449,806	B1 *	9/2002	Engelhard	.....	H04M 1/05 2/209

D508,483	S *	8/2005	Suzuki	.....	D14/205
D512,708	S *	12/2005	Harris, Jr.	.....	D14/205
D519,497	S *	4/2006	Komiyama	.....	D14/223
D560,654	S *	1/2008	Feng	.....	D14/205
D570,825	S *	6/2008	Schultz	.....	D14/205
D635,958	S *	4/2011	Ando	.....	D14/205
8,189,847	B2 *	5/2012	Huang	.....	H04R 1/1075 381/186
D668,633	S *	10/2012	Enquist	.....	D14/205
D700,590	S *	3/2014	Heath	.....	D14/205

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*Primary Examiner* — Paula Allen Greene

(74) *Attorney, Agent, or Firm* — Renner, Otto, Boisselle and Sklar, LLP

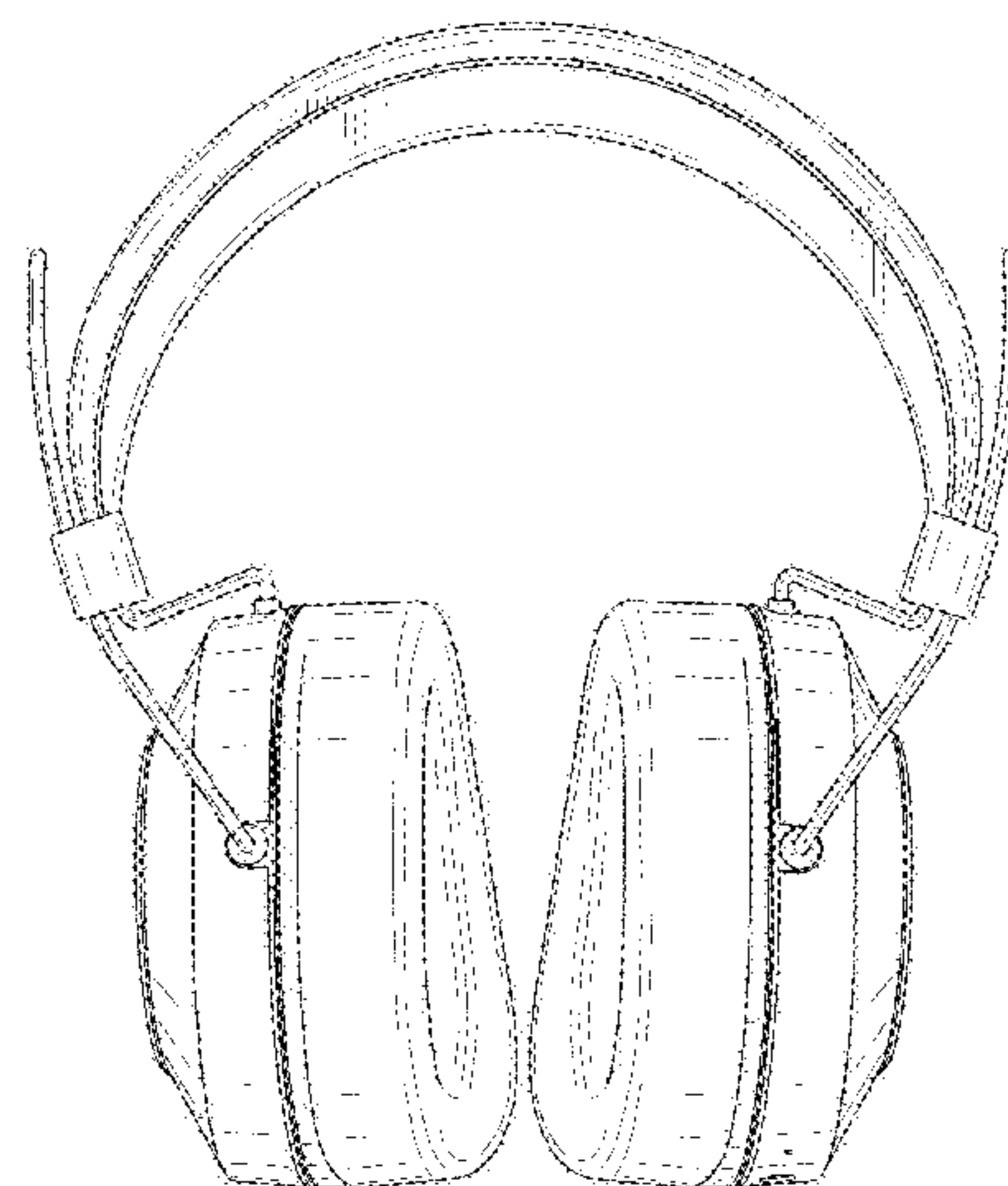
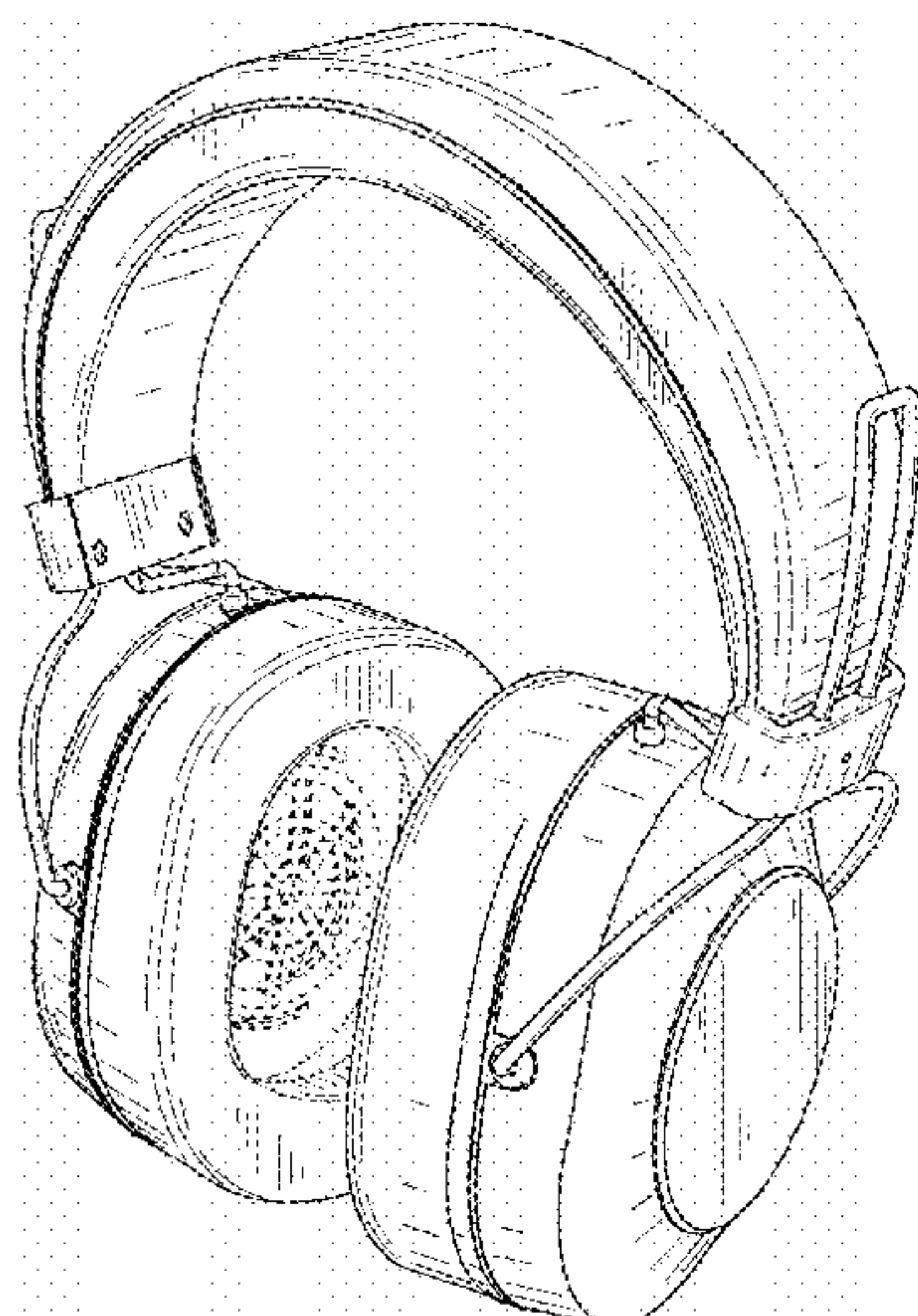
(57) **CLAIM**

The ornamental design for headphones, as shown and described.

**DESCRIPTION**

FIG. 1 is a top, front, right perspective view of a first embodiment of headphones showing my new design; FIG. 2 is a front elevation view thereof; FIG. 3 is a rear elevation view thereof; FIG. 4 is a top plan view thereof; FIG. 5 is a bottom plan view thereof; FIG. 6 is a left side elevation view thereof; FIG. 7 is a right side elevation view thereof; FIG. 8 is a top, front, right perspective view of a second embodiment of headphones showing my new design; FIG. 9 is a front elevation view thereof; FIG. 10 is a rear elevation view thereof; FIG. 11 is a top plan view thereof; FIG. 12 is a bottom plan view thereof; FIG. 13 is a left side elevation view thereof; and, FIG. 14 is a right side elevation view thereof. The broken lines depict portions of the headphones that form no part of the claimed design.

**1 Claim, 14 Drawing Sheets**



(56)

**References Cited**

U.S. PATENT DOCUMENTS

D703,183 S \* 4/2014 Moriya ..... H04S 1/005  
D14/206  
D732,001 S \* 6/2015 Licht ..... D14/205  
D740,254 S \* 10/2015 Huang ..... D14/205  
D761,761 S \* 7/2016 Ando ..... D14/205  
D766,520 S \* 9/2016 Fletcher ..... D29/112  
D778,874 S \* 2/2017 Lin ..... D14/205  
D809,474 S \* 2/2018 Attal ..... D14/205  
D811,365 S \* 2/2018 Czaniecki ..... D14/205  
2009/0279729 A1 \* 11/2009 Huang ..... H04R 1/1016  
381/345  
2015/0382099 A1 \* 12/2015 Chu ..... H04R 1/2811  
381/370  
2016/0205458 A1 \* 7/2016 Huang ..... H04R 1/1016  
381/380  
2016/0330542 A1 \* 11/2016 Hsiao ..... H04R 1/1091  
2017/0064436 A1 \* 3/2017 Tamura ..... H04R 1/1066

\* cited by examiner

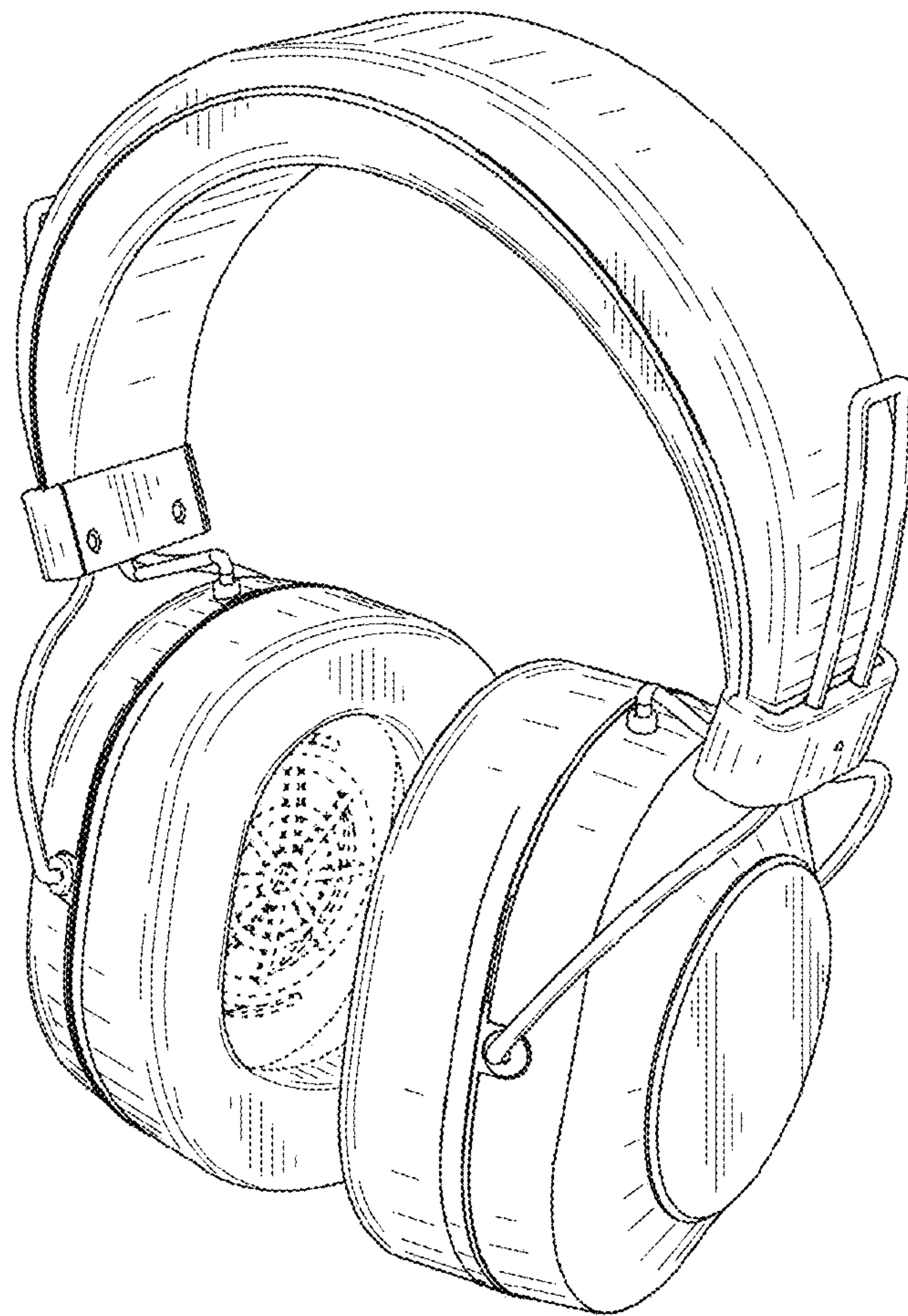


FIG. 1





FIG. 2

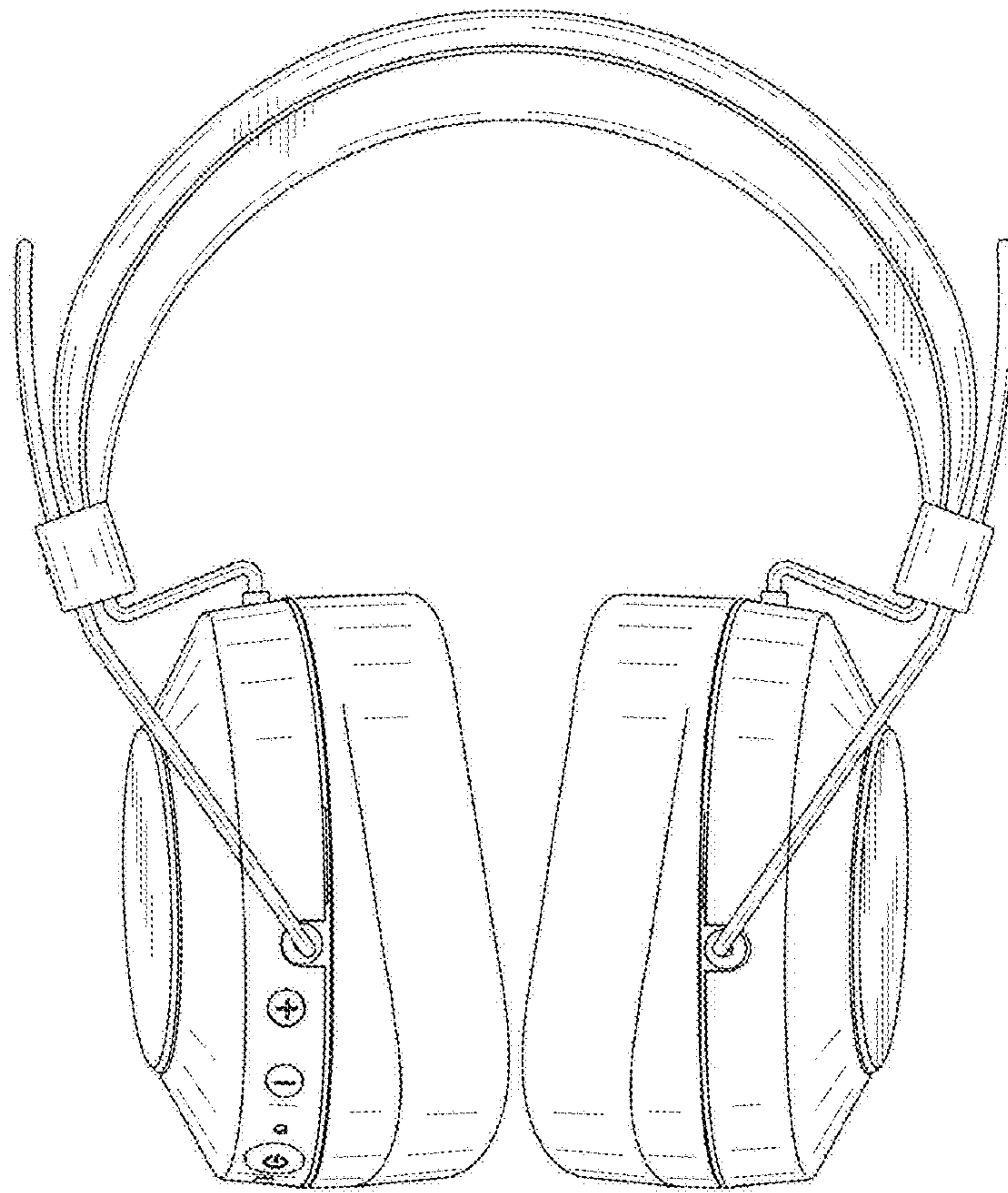


FIG. 3

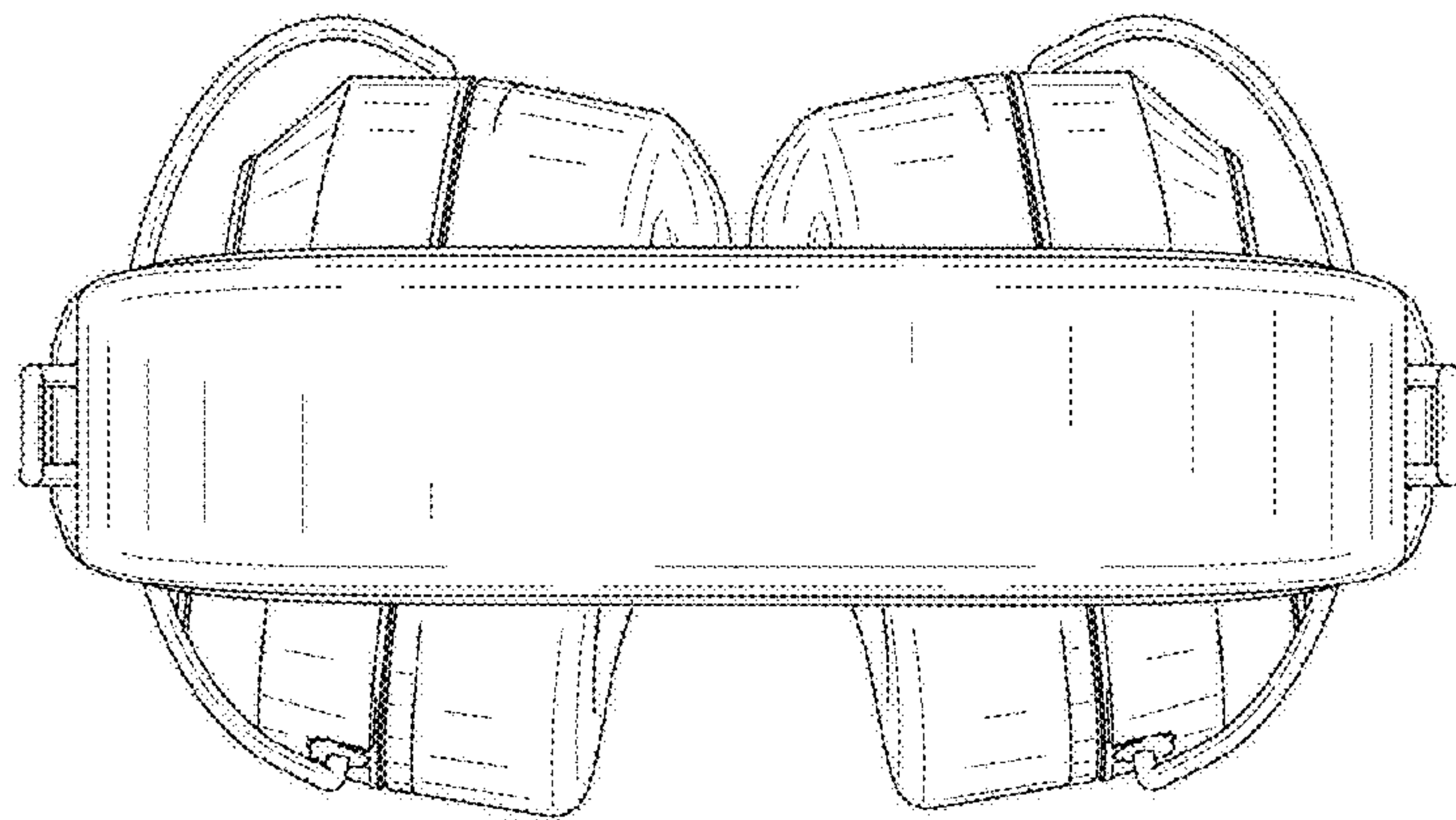


FIG. 4

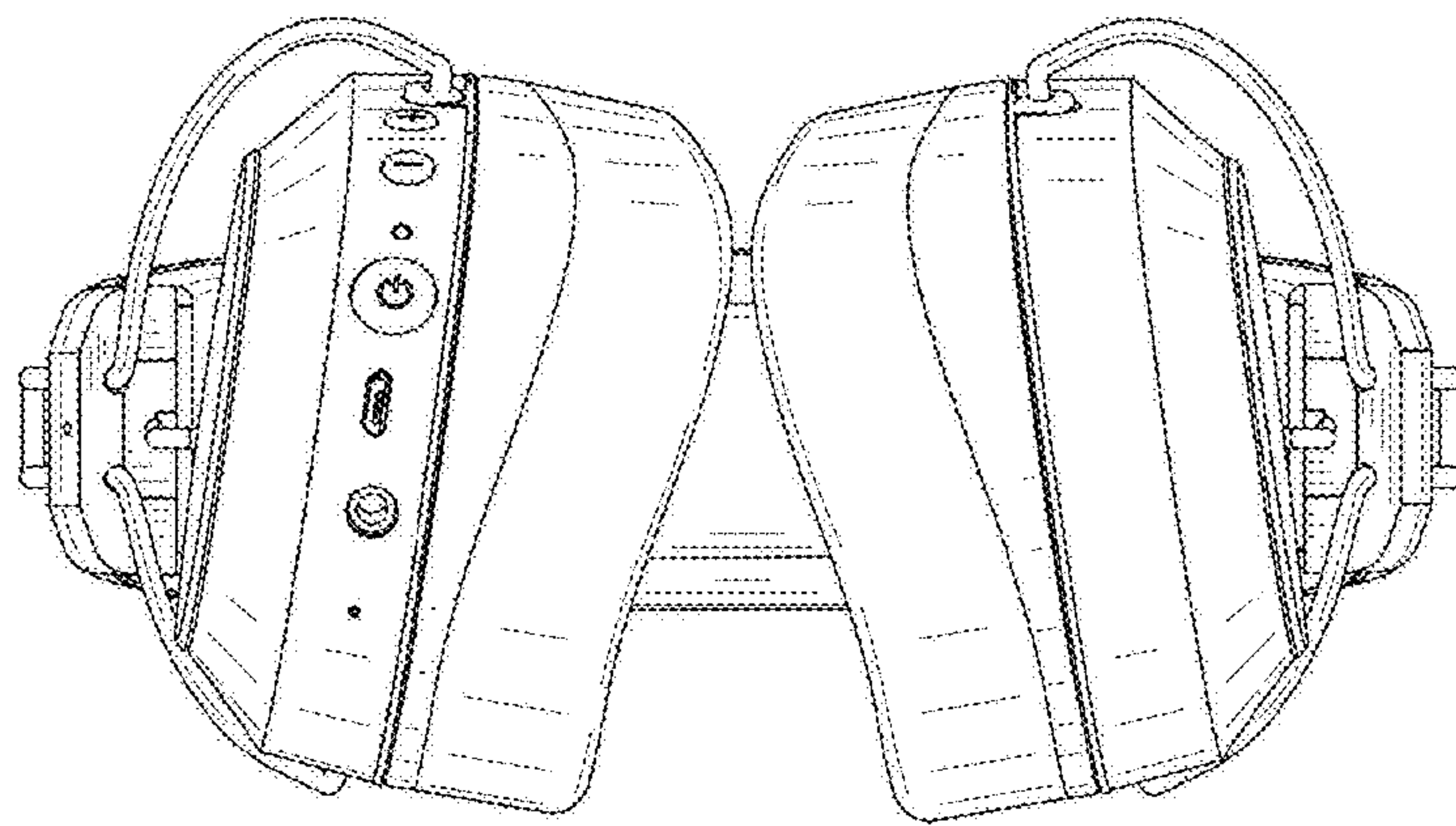


FIG. 5

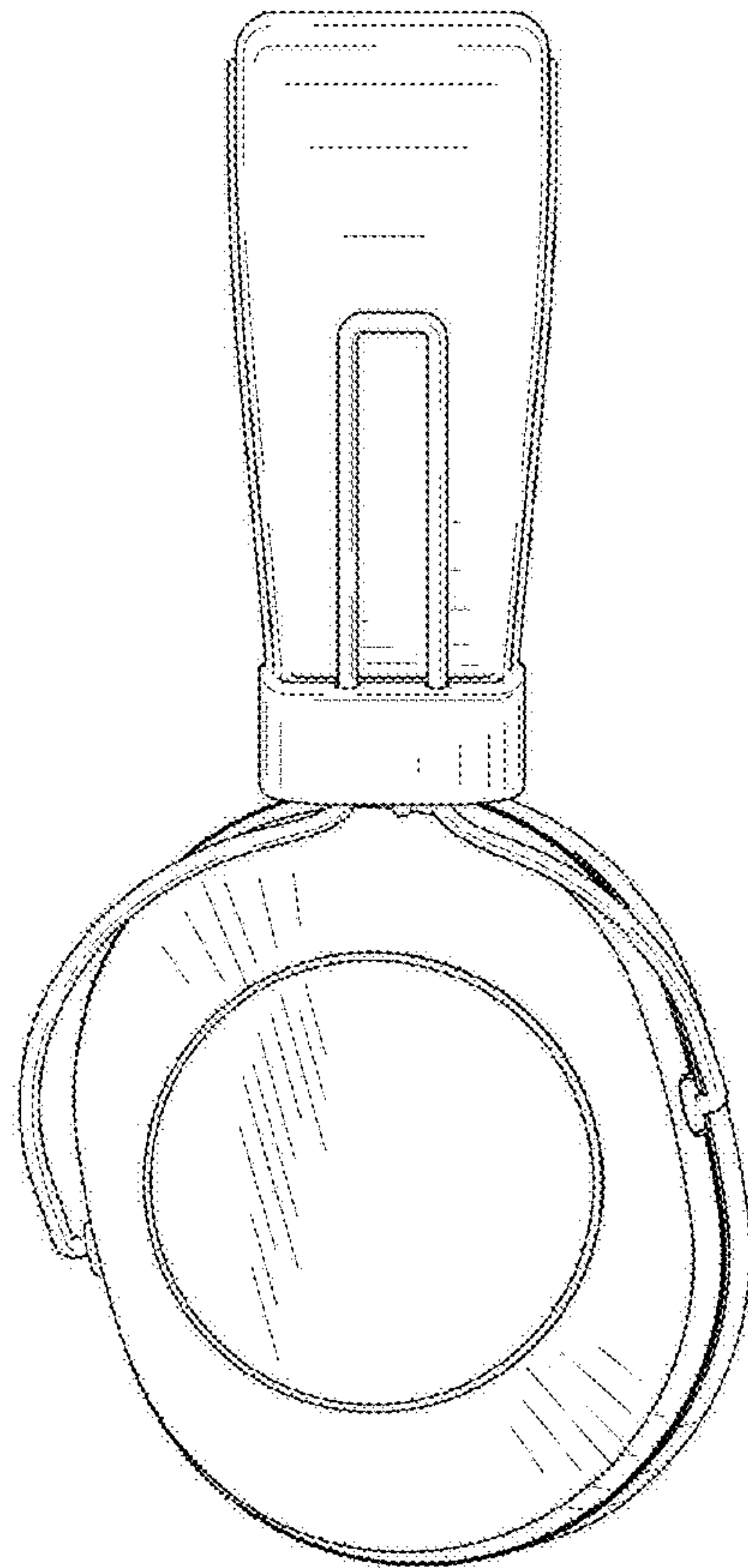


FIG. 6



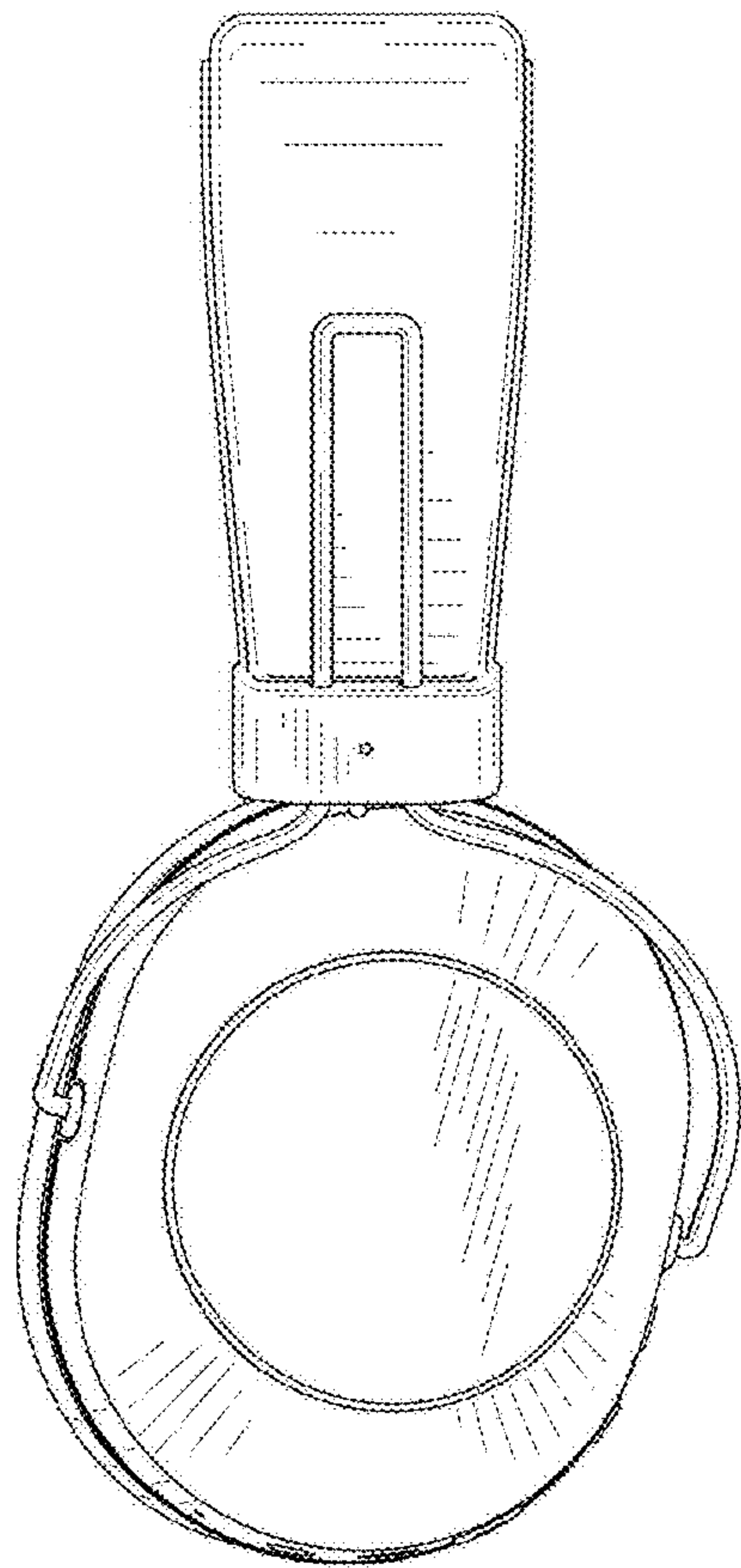


FIG. 7

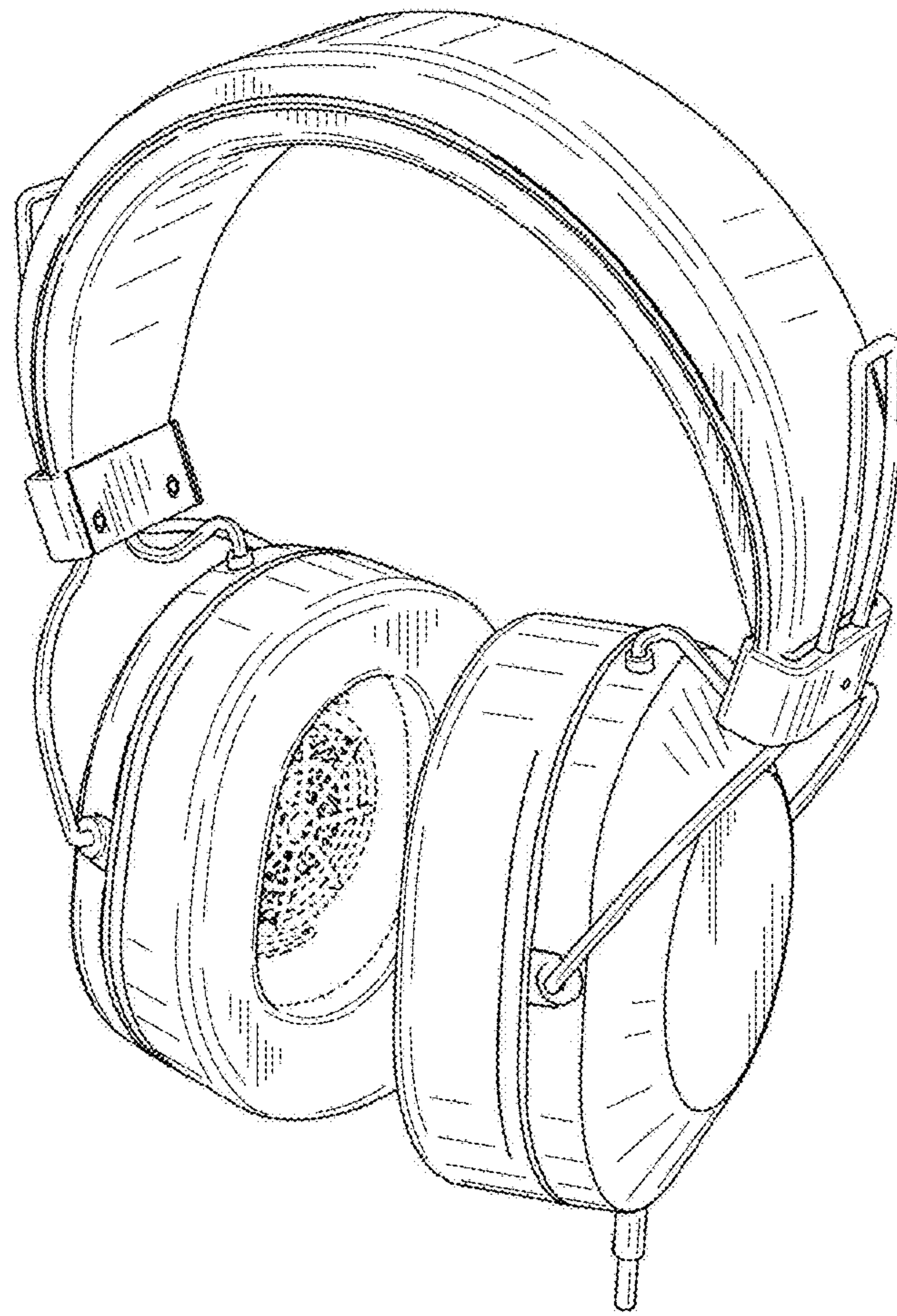


FIG. 8

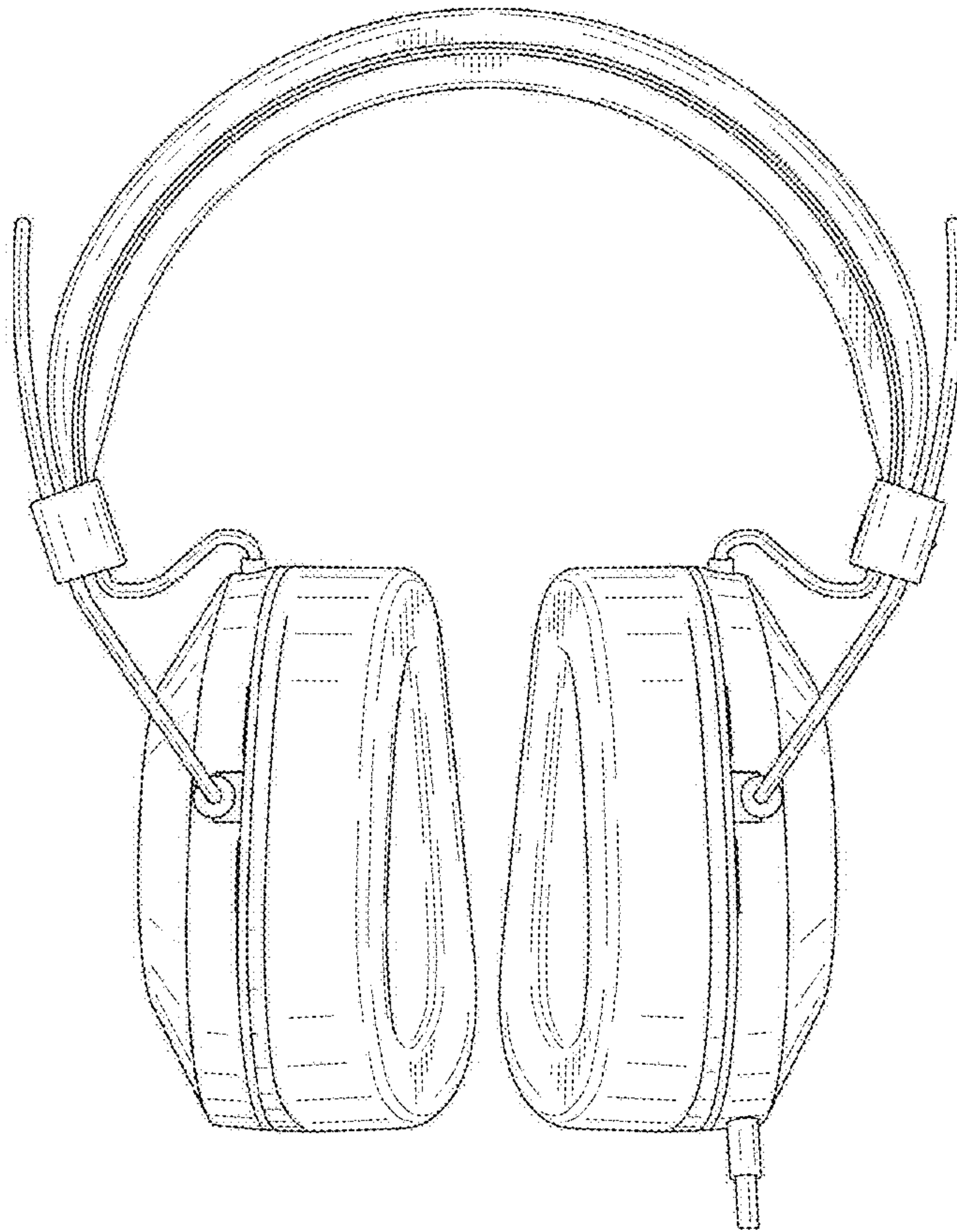


FIG. 9

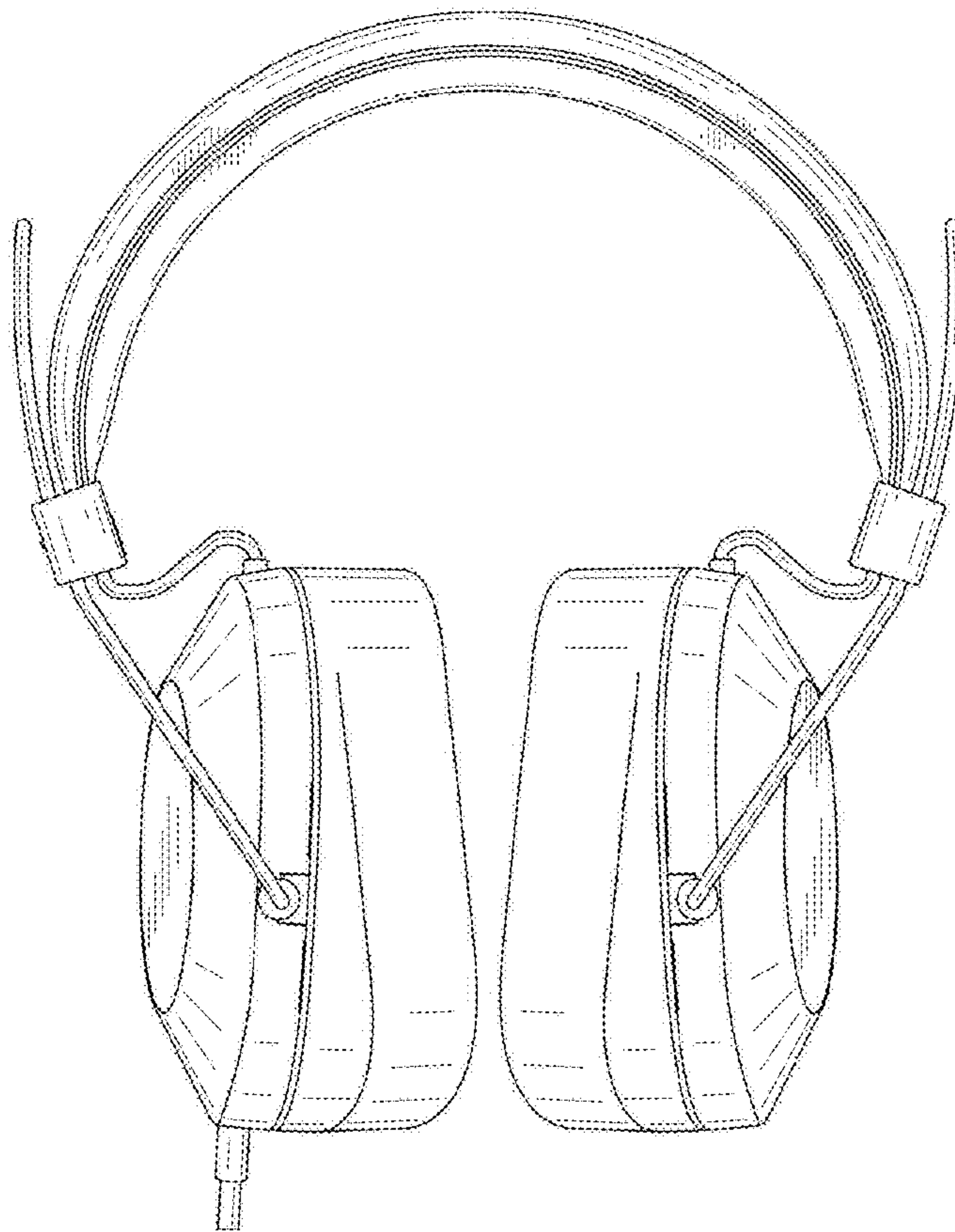


FIG. 10

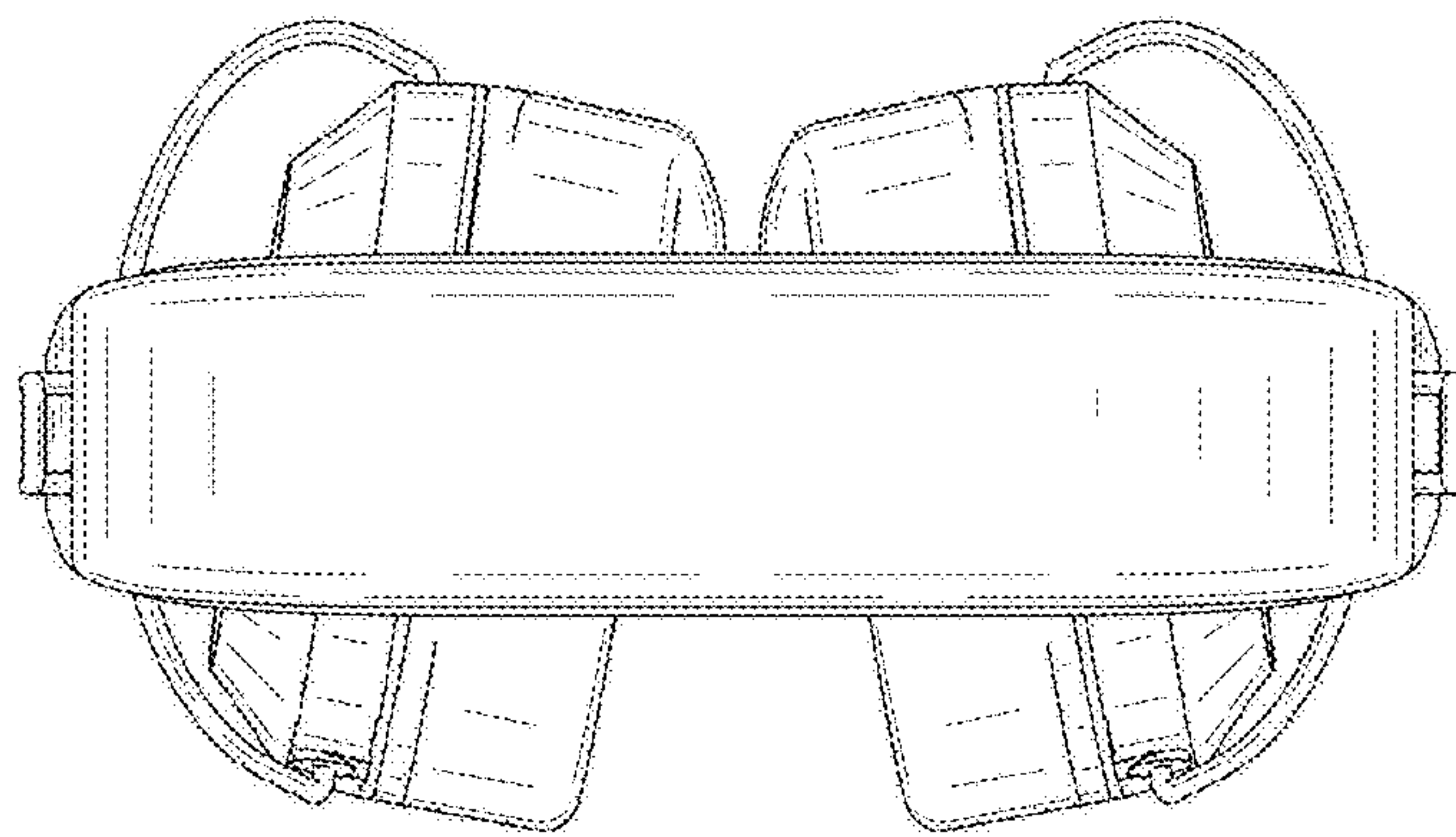


FIG. 11



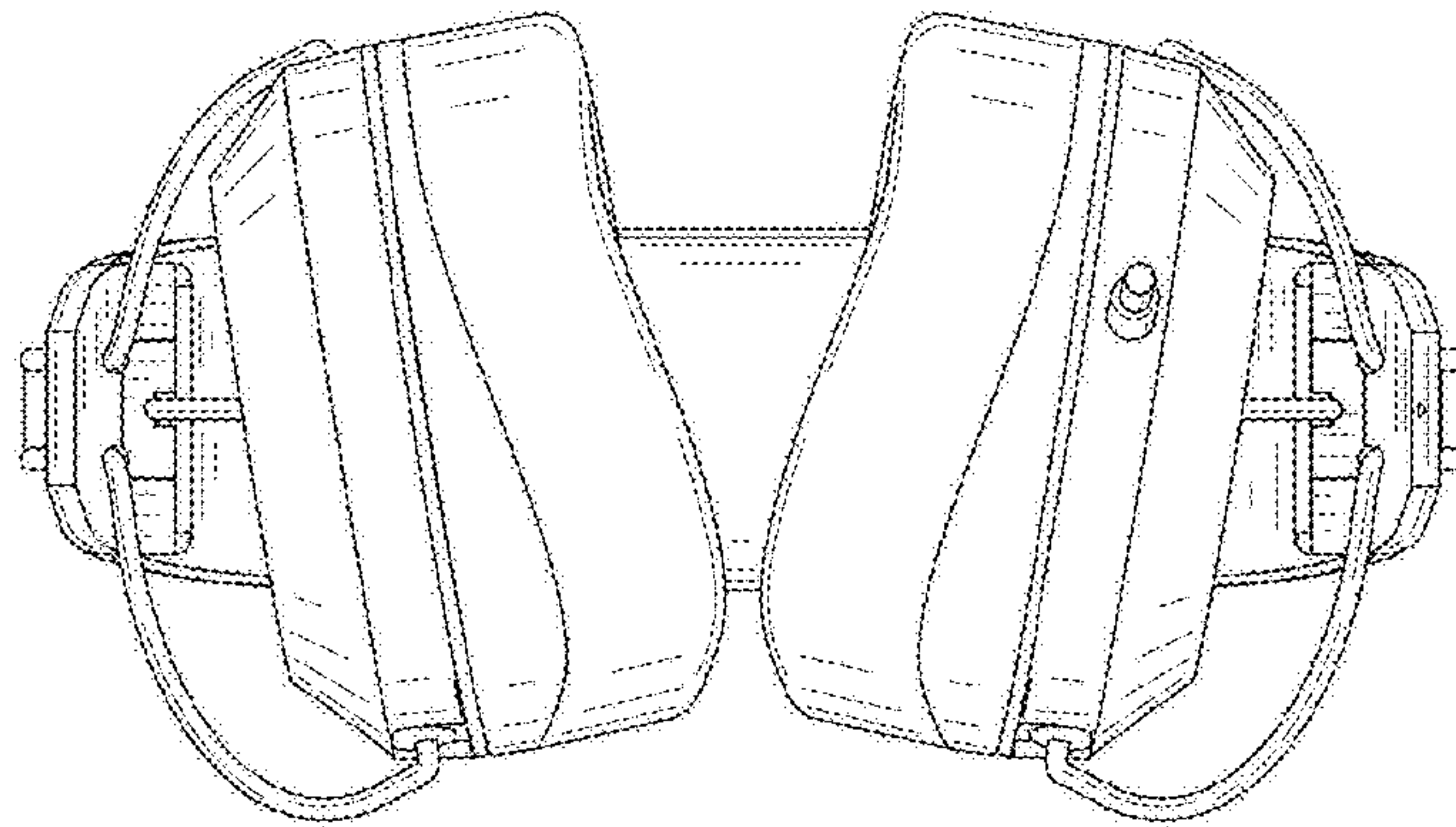


FIG. 12

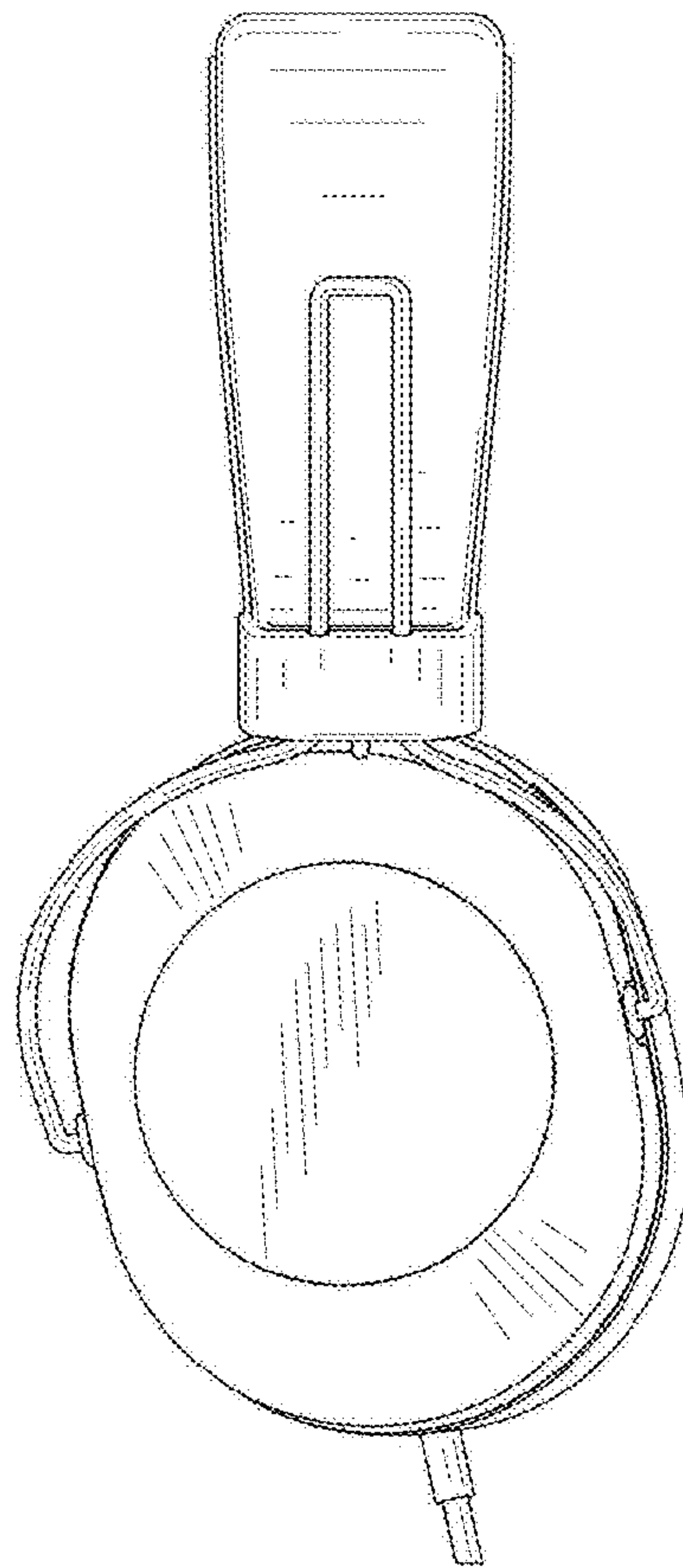


FIG. 13

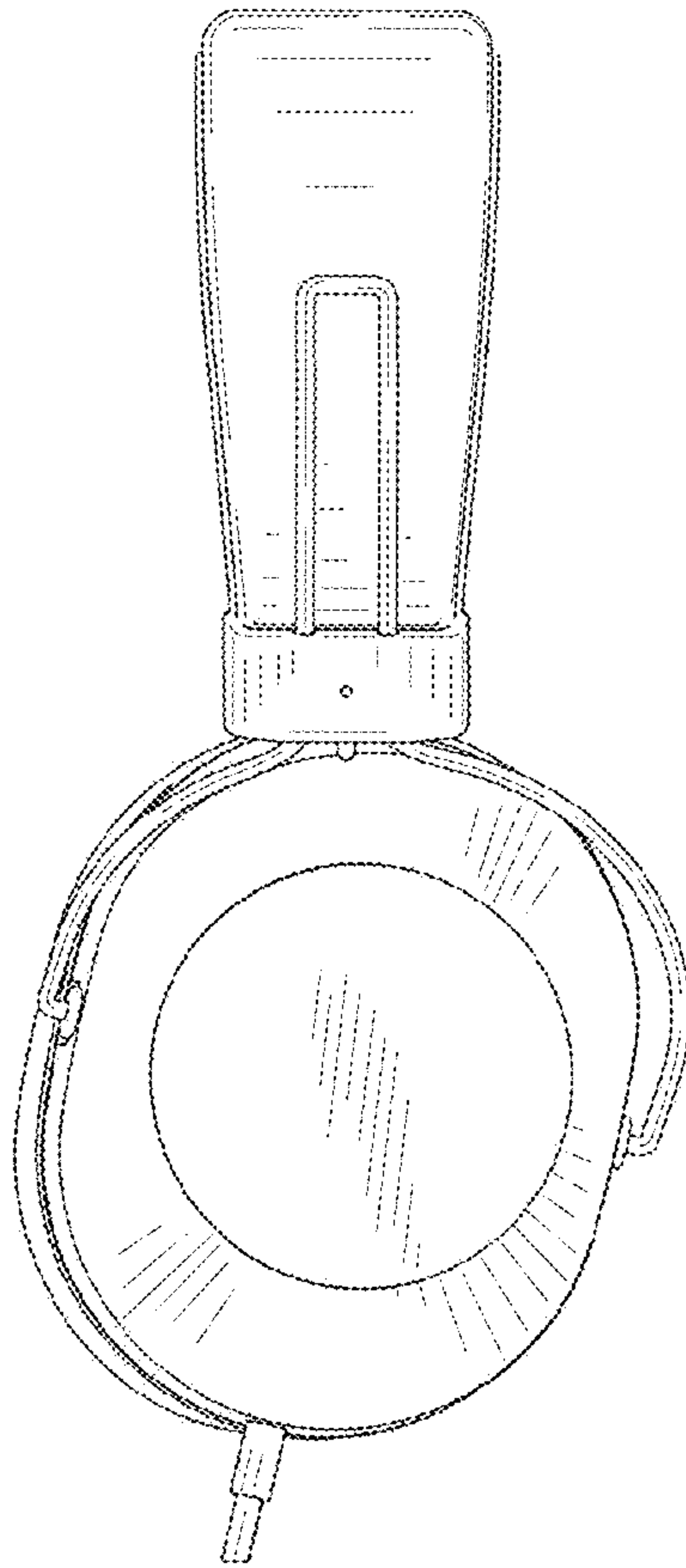


FIG. 14